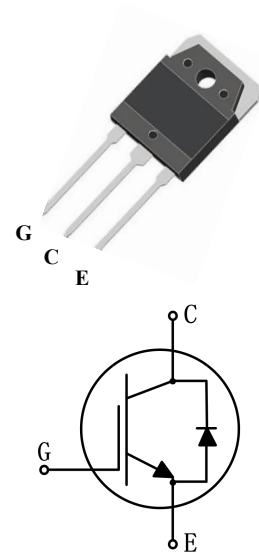


**Key performance:**

- $V_{CE}=1350V$
- $I_C=30A@T_C=100^{\circ}C$
- $V_{CE(sat)}=2.1V$

**Features:**

- Trench and field-stop technology
- High speed switching
- Positive  $V_{CE(sat)}$  temperature coefficient.
- Fast switching and short tail current.
- High ruggedness performance

**TO-3P**

**Applications:**

- Induction cooking
- Resonant converters

**Package parameters**

Type	Marking	Package	Packaging Method
JJT30N135UH	T30135UH	TO-3P	Tube

## Maximum ratings

Symbol	Parameter	Values	Unit
$V_{CES}$	Collector-emitter voltage	1350	V
$V_{GES}$	Gate-emitter voltage	$\pm 20$	V
$I_C$	Continuous collector current ( $T_C=25^\circ\text{C}$ )	60	A
	Continuous collector current ( $T_C=100^\circ\text{C}$ )	30	A
$I_{CM}$	Pulsed collector current, $t_p$ limited by $T_{vjmax}$	120	A
$I_F$	Diode continuous forward current ( $T_C=100^\circ\text{C}$ )	30	A
$I_{FM}$	Diode maximum current, $t_p$ limited by $T_{vjmax}$	120	A
$P_{tot}$	Power dissipation ( $T_C=25^\circ\text{C}$ )	416	W
	Power dissipation ( $T_C=100^\circ\text{C}$ )	208	W
$T_{vj}$	Operating junction temperature range	-40 to +175	$^\circ\text{C}$
$T_{stg}$	Storage temperature range	-55 to +150	$^\circ\text{C}$

## Thermal characteristics

Symbol	Parameter	Values		Unit
		Typ.	Max.	
$R_{th(j-c)}$	Thermal resistance, junction to case for IGBT	-	0.36	K/ W
$R_{th(j-c)}$	Thermal resistance, junction to case for Diode	-	1.40	K/ W
$R_{th(j-a)}$	Thermal resistance, junction to ambient	-	40	K/ W

**Electrical characteristics of IGBT** ( $T_{vj}=25^{\circ}\text{C}$  unless otherwise specified)

**Static characteristics**

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
$BV_{CES}$	Collector-emitter breakdown voltage	$V_{GE}=0\text{V}, I_C=250\mu\text{A}$	1350	-	-	V
$I_{CES}$	Collector-emitter leakage current	$V_{CE}=1350\text{V}, V_{GE}=0\text{V}$	-	-	100	$\mu\text{A}$
$I_{GES}$	Gate leakage current, forward	$V_{GE}=20\text{V}, V_{CE}=0\text{V}$	-	-	100	nA
	Gate leakage current, reverse	$V_{GE}=-20\text{V}, V_{CE}=0\text{V}$	-	-	-100	nA
$V_{GE(th)}$	Gate-emitter threshold voltage	$V_{GE}=V_{CE}, I_C=1\text{mA}$	5.0	5.4	6.0	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE}=15\text{V}, I_C=30\text{A}$	-	2.1	-	V
		$V_{GE}=15\text{V}, I_C=30\text{A}, T_{vj}=175^{\circ}\text{C}$	-	2.8	-	V

**Dynamic characteristics**

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
$C_{ies}$	Input capacitance	$V_{CE}=30\text{V}$ $V_{GE}=0\text{V}$ $f=1\text{MHz}$	-	4530	-	pF
$C_{oes}$	Output capacitance		-	54	-	pF
$C_{res}$	Reverse transfer capacitance		-	25	-	pF
$Q_g$	Total gate charge	$V_{CC}=1080\text{V}$ $V_{GE}=15\text{V}$ $I_C=30\text{A}$	-	149	-	nC

### Switching characteristics

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
$t_{d(off)}$	Turn-off delay time	$V_{CC}=600V$ $V_{GE}=0/15V$	-	176	-	ns
$t_f$	Fall time	$I_C=30A$ $R_G=10\Omega$	-	132	-	ns
$E_{off}$	Turn-off energy	Inductive load	-	1.3	-	mJ
$t_{d(off)}$	Turn-off delay time	$V_{CC}=600V$ $V_{GE}=0/15V$	-	201	-	ns
$t_f$	Fall time	$I_C=30A$ $R_G=10\Omega, T_{vj}=175^\circ C$	-	229	-	ns
$E_{off}$	Turn-off energy	Inductive load	-	1.7	-	mJ

### Electrical characteristics of Diode ( $T_{vj}=25^\circ C$ unless otherwise specified)

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
$V_F$	Diode forward voltage	$I_F=30A$	-	2.8	-	V
		$I_F=30A, T_{vj}=175^\circ C$	-	2.7	-	V

## Typical performance characteristics

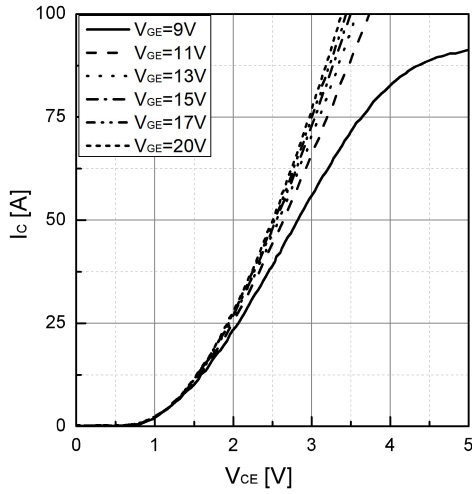


Fig 1. Typical output characteristic ( $T_{vj}=25^{\circ}\text{C}$ )

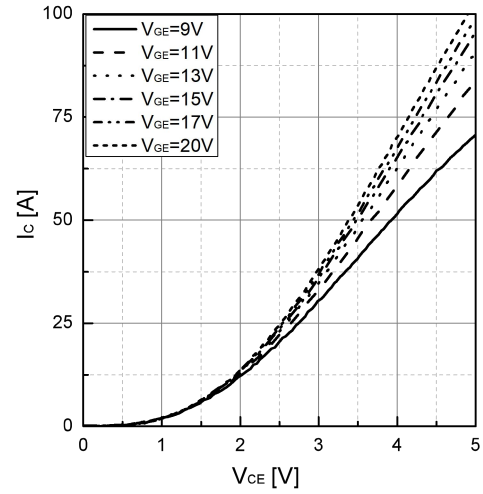


Fig 2. Typical output characteristic ( $T_{vj}=175^{\circ}\text{C}$ )

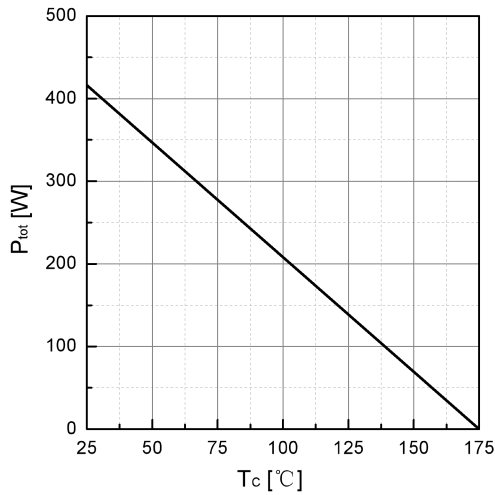


Fig 3. Power dissipation as a function of  $T_c$

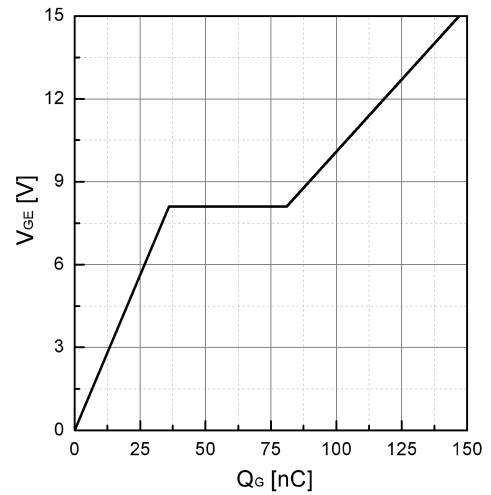


Fig 4. Typical Gate charge

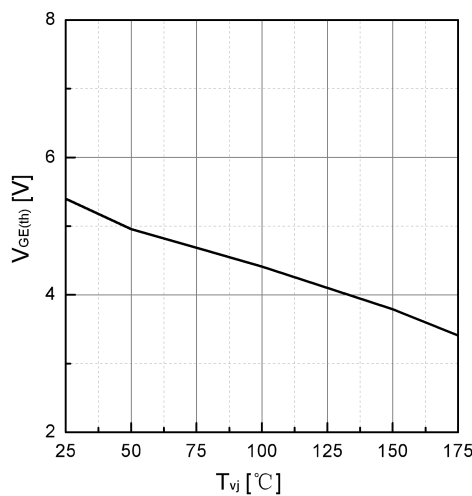


Fig 5. Typical  $V_{GE(th)}$  as a function of  $T_{vj}$   
( $I_C=1\text{mA}$ )

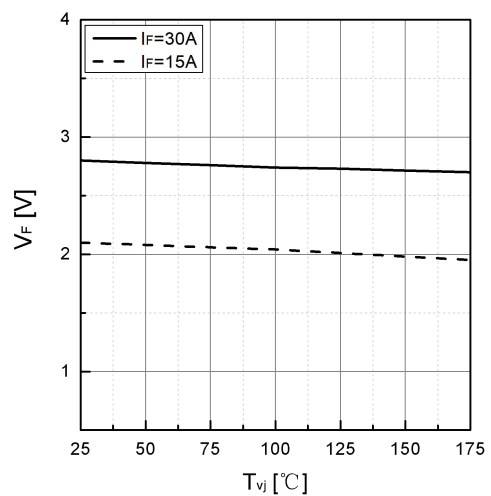


Fig 6. Typical  $V_F$  as a function of  $T_{vj}$

## Typical performance characteristics

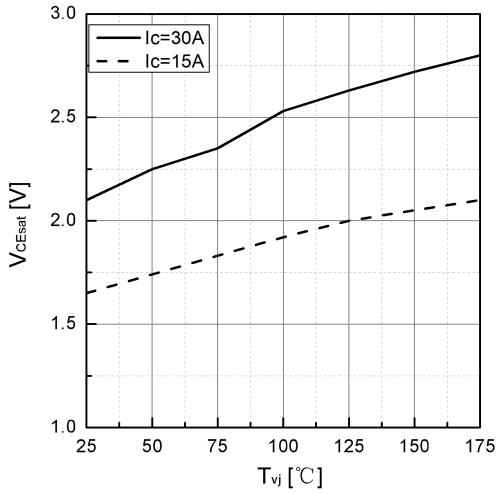


Fig 7. Typical  $V_{CEsat}$  as a function of  $T_{vj}$

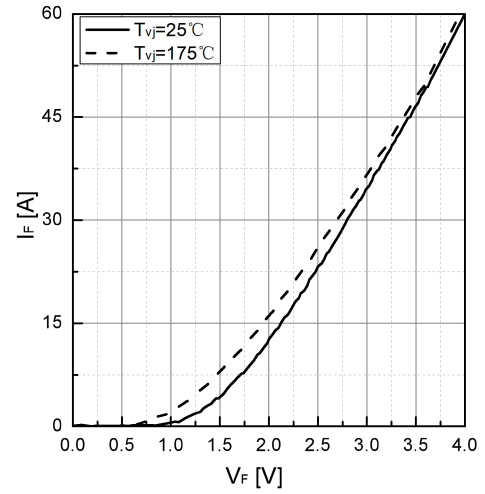


Fig 8. Typical  $I_F$  as a function of  $V_F$

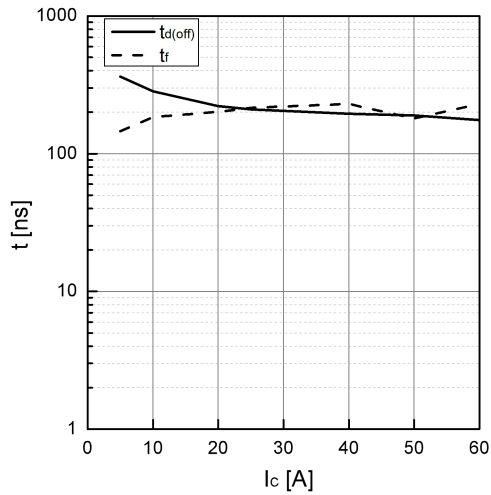


Fig 9. Typical switching time as a function of  $I_c$

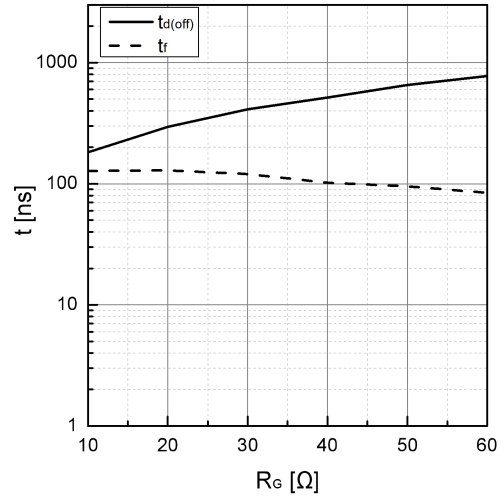


Fig 10. Typical switching times as a function of  $R_G$

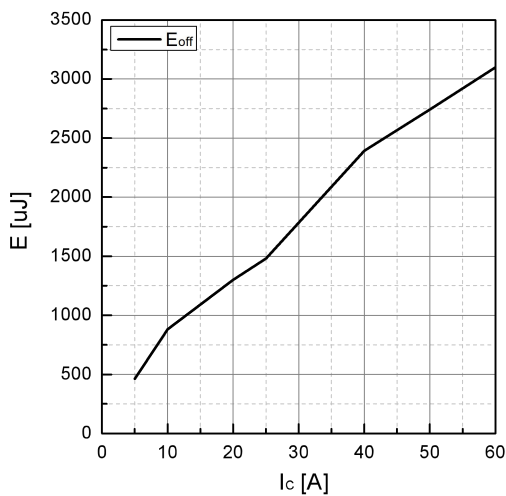


Fig 11. Typical switching energy losses as a function of  $I_c$

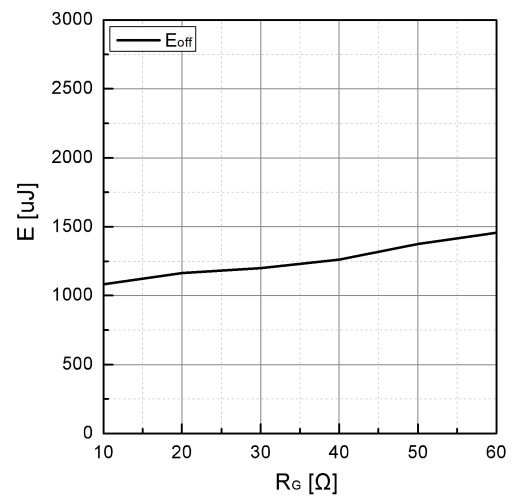


Fig 12. Typical switching energy losses as a function of  $R_G$

### Typical performance characteristics

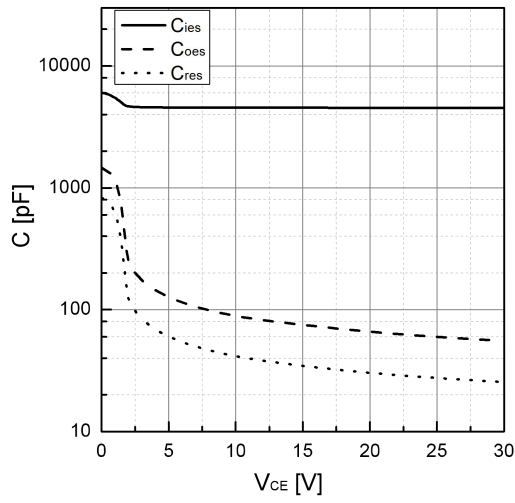


Fig 13. Typical capacitance as a function of  $V_{CE}$   
( $f=1\text{MHz}$ ,  $V_{GE}=0\text{V}$ )

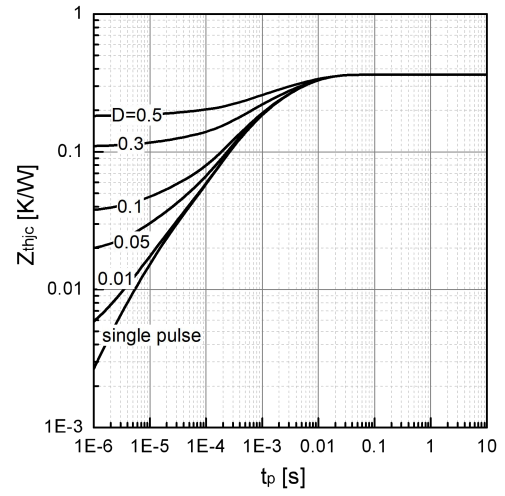
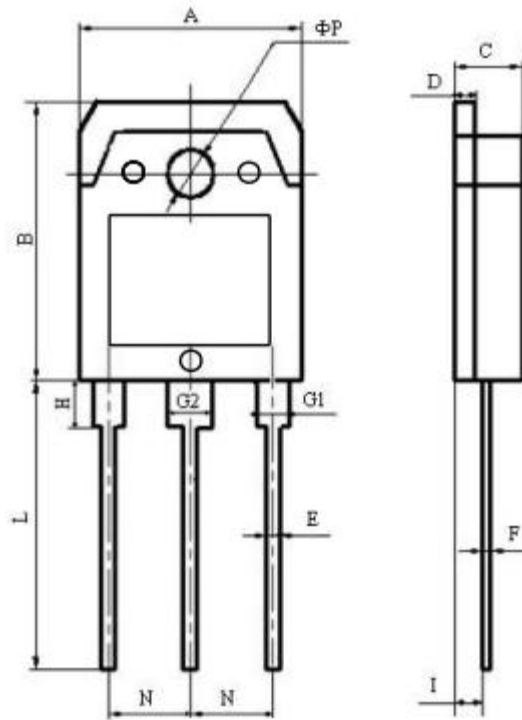


Fig 14. Transient thermal impedance of IGBT

**Package dimension**

TO-3P



Items	Values(mm)	
	MIN	MAX
A	15.00	16.00
B	19.20	20.60
C	4.60	5.00
D	1.40	1.60
E	0.90	1.10
F	0.50	0.70
G1	2.00	2.20
G2	3.00	3.20
H	3.00	3.70
I	2.30	2.50
L*	19.00	21.00
N	5.25	5.65
$\Phi P$	3.10	3.30

## Revision history

Date	Revision	Changes
2025-04-22	Rev 1.0	Release of the datasheet

## Disclaimer

PLEASE NOTE - Jiangsu JieJie Microelectronics Co., Ltd ("JJM") reserves the right to amend, correct, modify and enhance the product and/or this document at any time without prior notice. If you intend to purchase this product, please obtain the latest information available before placing your order. The sale of JJM products is governed by JJM's prevailing terms and conditions at the time of purchase and purchasers are solely responsible for the selection and use of the products with no liability on JJM's part to supply application assistance or customization. Purchase of JJM products does not grant the purchaser license, express or implied, to JJM's intellectual property. Any warranties provided with JJM products are null and void upon resale unless accompanied by the information set forth herein in its entirety. The JJM name and logo are registered trademarks of Jiangsu JieJie Microelectronics Co., Ltd. This document supersedes all previous versions. ©2025 JJM - All rights reserved